**Amendments in the Claims:** 

Please cancel claims 1 and 5 without prejudice or disclaimer. Please amend claims 2-4

and 6-7, and add new 8, as follows:

Claim 1. (Canceled)

Claim 2. (Currently amended) A minute droplet forming method according to claim [1]

3, wherein a size of said droplet to be formed is adjusted by controlling said setback force.

Claim 3. (Currently amended) A minute droplet forming method [according to claim 1,]

of electrostatic attraction type for forming a minute droplet by attracting a liquid by applying a

pulse voltage to a nozzle tip containing said liquid, said method comprising:

a step of applying said pulse voltage between a substrate arranged to face said nozzle tip

with a predetermined space therebetween and said liquid within said nozzle so as to project said

liquid from said nozzle tip and form a liquid column; and

a step of isolating said droplet by enhancing a fluid resistance within said nozzle so as to

cause a setback force for returning said liquid into said nozzle to act on said formed liquid

column,

wherein each of said forming and isolating of said droplet is carried out under a saturation

vapor pressure of said liquid.

1-WA/2175739.1

Claim 4. (Currently amended) A minute droplet forming method [according to claim 1,] of electrostatic attraction type for forming a minute droplet by attracting a liquid by applying a pulse voltage to a nozzle tip containing said liquid, said method comprising:

a step of applying said pulse voltage between a substrate arranged to face said nozzle tip with a predetermined space therebetween and said liquid within said nozzle so as to project said liquid from said nozzle tip and form a liquid column; and

a step of isolating said droplet by enhancing a fluid resistance within said nozzle so as to cause a setback force for returning said liquid into said nozzle to act on said formed liquid column,

wherein said nozzle is a core nozzle having a core arranged therewithin.

Claim 5. (Canceled)

Claim 6. (Currently amended) A minute droplet forming apparatus [according to claim 5,] comprising:

a nozzle for storing therewithin a liquid for forming a droplet;

a substrate, arranged so as to face a tip of said nozzle, for mounting said droplet dropped from said nozzle tip;

a pulse power supply for applying a pulse voltage between said liquid within said nozzle and said substrate;

a fluid regulating unit adapted to change a fluid resistance within said nozzle; and
a control unit for controlling said pulse power supply and said fluid regulating unit,
1-wa/2175739.1

further comprising an environment maintaining unit for causing surroundings of said tip of said nozzle and said substrate to keep a saturation vapor pressure environment of said liquid within said nozzle.

Claim 7. (Currently amended) A minute droplet forming apparatus [according to claim 5,] comprising:

a nozzle for storing therewithin a liquid for forming a droplet;

a substrate, arranged so as to face a tip of said nozzle, for mounting said droplet dropped from said nozzle tip;

a pulse power supply for applying a pulse voltage between said liquid within said nozzle and said substrate;

a fluid regulating unit adapted to change a fluid resistance within said nozzle; and a control unit for controlling said pulse power supply and said fluid regulating unit, wherein said nozzle is a core nozzle having a core arranged within said nozzle.

Claim 8. (New) A minute droplet forming method according to claim 4, wherein a size of said droplet to be formed is adjusted by controlling said setback force.